

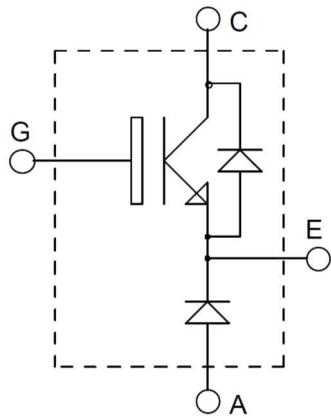
## Buck Chopper with Field Stop Trench IGBT + SiC SBD



$V_{CES} = 1200V$   
 $I_C = 80A @ T_C = 100^{\circ}C$

### Features

- **Field StopTrench Fast IGBT**
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 50 kHz
  - Low leakage current
- **Chopper SiC Schottky Diode**
  - Zero reverse recovery current
  - Temperature Independent switching behavior
  - Positive temperature coefficient on VF



### Applications

- Solar inverters
- AC and DC motor control
- Power Factor Correction
- Aerospace Actuators



### Benefits

- Outstanding performance at high frequency operation
- Low switching losses
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive  $T_C$  of  $V_{CESat}$
- RoHS Compliant

### Absolute Maximum Ratings ( $T_J=25^{\circ}C$ unless otherwise specified)

| Parameters                            | Symbol    | Conditions           | Specifications | Units       |
|---------------------------------------|-----------|----------------------|----------------|-------------|
| Collector - Emitter Breakdown Voltage | $V_{CES}$ |                      | 1200           | V           |
| Continuous Collector Current          | $I_C$     | $T_C = 25^{\circ}C$  | 160            | A           |
|                                       |           | $T_C = 100^{\circ}C$ | 80             | A           |
| Gate-Emitter Voltage                  | $V_{GES}$ |                      | $\pm 20$       | V           |
| Pulsed Collector Current              | $ICM$     |                      | 240            | A           |
| Maximum Power Dissipation             | $P_D$     | $T_C = 25^{\circ}C$  | 480            | W           |
|                                       |           | $T_C = 100^{\circ}C$ | 200            | W           |
| Operating Junction Temperature        | $T_J$     |                      | -55 ~ 150      | $^{\circ}C$ |
| Storage Temperature                   | $T_{STG}$ |                      | -55 ~ 150      | $^{\circ}C$ |

**Electrical Characteristics (T<sub>j</sub>=25°C unless otherwise specified)**

| Parameters                           | Symbol               | Conditions   | Min | Typ  | Max  | Units |
|--------------------------------------|----------------------|--|-----|------|------|-------|
| <b>OFF</b>                           |                      |  |     |      |      |       |
| Zero Gate Voltage Collector Current  | I <sub>CES</sub>     | V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V  | --  | --   | 2    | mA    |
| Gate-Emitter Leakage Current         | I <sub>GES</sub>     | V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V  | --  | --   | ±500 | nA    |
| <b>ON</b>                            |                      |  |     |      |      |       |
| Gate-Emitter Threshold Voltage       | V <sub>GE(TH)</sub>  | V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 80mA  | 4.5 | 6.5  | 8.5  | V     |
| Collector-Emitter Saturation Voltage | V <sub>CE(SAT)</sub> | V <sub>CE</sub> = 15V, I <sub>C</sub> = 80A, T <sub>j</sub> = 25 °C  | --  | 2.0  | 2.6  | V     |
|                                      |                      | V <sub>CE</sub> = 15V, I <sub>C</sub> = 80A, T <sub>j</sub> = 125 °C   | --  | 2.45 | --   | V     |
| <b>DYNAMIC</b>                       |                      |  |     |      |      |       |
| Input Capacitance                    | C <sub>IES</sub>     | V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1 MHz   | --  | 10.3 | --   | nF    |
| Output Capacitance                   | C <sub>OES</sub>     |  | --  | 300  | --   | pF    |
| Reverse Transfer Capacitance         | C <sub>RES</sub>     |  | --  | 200  | --   | pF    |
| <b>SWITCHING</b>                     |                      |  |     |      |      |       |
| Turn-On Delay Time                   | t <sub>d(on)</sub>   | V <sub>CE</sub> = 600V, I <sub>C</sub> = 80A<br>R <sub>G</sub> = 10Ω, V <sub>GE</sub> = 15V<br>Inductive Load, T <sub>j</sub> = 25 °C  | --  | 60   | --   | ns    |
| Rise Time                            | t <sub>r</sub>       |  | --  | 85   | --   | ns    |
| Turn-Off Delay Time                  | t <sub>d(off)</sub>  |  | --  | 200  | --   | ns    |
| Fall Time                            | t <sub>f</sub>       |  | --  | 60   | --   | ns    |
| Turn-On Switching Energy Loss        | E <sub>ON</sub>      |  | --  | 7.1  | --   | mJ    |
| Turn-Off Switching Energy Loss       | E <sub>OFF</sub>     |  | --  | 1.2  | --   | mJ    |
| Turn-On Delay Time                   | t <sub>d(on)</sub>   | V <sub>CE</sub> = 600V, I <sub>C</sub> = 80A<br>R <sub>G</sub> = 10Ω, V <sub>GE</sub> = 15V<br>Inductive Load, T <sub>j</sub> = 125 °C | --  | 50   | --   | ns    |
| Rise Time                            | t <sub>r</sub>       |  | --  | 80   | --   | ns    |
| Turn-Off Delay Time                  | t <sub>d(off)</sub>  |  | --  | 210  | --   | ns    |
| Fall Time                            | t <sub>f</sub>       |  | --  | 120  | --   | ns    |
| Turn-On Switching Energy Loss        | E <sub>ON</sub>      |  | --  | 7.6  | --   | mJ    |
| Turn-Off Switching Energy Loss       | E <sub>OFF</sub>     |  | --  | 2.4  | --   | mJ    |
| Total Gate Charge                    | Q <sub>g</sub>       | V <sub>CE</sub> = 600V, I <sub>C</sub> = 80A<br>V <sub>GE</sub> = 15V  | --  | 640  | 960  | nC    |
| Gate-Emitter Charge                  | Q <sub>ge</sub>      |  | --  | 80   | 120  | nC    |
| Gate-Collector Charge                | Q <sub>gc</sub>      |  | --  | 300  | 450  | nC    |
| Short Circuit Withstanding Time      | t <sub>sc</sub>      | V <sub>CE</sub> = 600V, V <sub>GE</sub> = 15V<br>T <sub>j</sub> = 125 °C   | --  | --   | 10   | μs    |

**SiC Diode Rating and Characteristics ( $T_j=25^\circ\text{C}$  unless otherwise specified)**

| Parameters                              | Symbol    | Conditions  | Min  | Typ  | Max | Units         |
|---|-----------|---|------|------|-----|---------------|
| Maximum peak repetitive reverse voltage | $V_{RRM}$ |   | 1200 | --   | --  | V             |
| Maximum Reverse Leakage Current         | $I_{RM}$  | $V_R = 1200\text{V}, T_j = 25^\circ\text{C}$                  | --   | 20   | 200 | $\mu\text{A}$ |
|   |           | $V_R = 1200\text{V}, T_j = 150^\circ\text{C}$                 | --   | 2424 | --  | $\mu\text{A}$ |
| Diode Forward Voltage                   | $V_F$     | $I_F = 40\text{A}, T_j = 25^\circ\text{C}$                    | --   | 1.5  | 1.7 | V             |
|   |           | $I_F = 40\text{A}, T_j = 150^\circ\text{C}$                   | --   | 2.3  | --  | V             |
| Total Capacitive Charge                 | $Q_C$     | $V_R=1200\text{ V}, I_F < I_{F,max}$                          | --   | 208  | --  | nC            |
| Switching Time                          | $t_C$     | $dI_F/dt = 200\text{ A}/\mu\text{s}, T_j = 175^\circ\text{C}$ | --   | --   | 20  | ns            |
| Total Capacitance                       | C         | $V_R = 1\text{V}, f = 1\text{ MHz}$                           | --   | 3600 | --  | pF            |
|   |           | $V_R = 600\text{V}, f = 1\text{ MHz}$                         | --   | 228  | --  | pF            |
|   |           | $V_R = 1200\text{V}, f = 1\text{ MHz}$                        | --   | 172  | --  | pF            |

**Thermal and Package Characteristics ( $T_j=25^\circ\text{C}$  unless otherwise specified)**

| Parameters                          | Symbol     | Conditions   | Min  | Typ | Max  | Units                     |
|-------------------------------------|------------|--|------|-----|------|---------------------------|
| Junction to Case Thermal Resistance | $R_{THJC}$ | IGBT chip  | --   | --  | 0.26 | $^\circ\text{C}/\text{W}$ |
|                                     |            | SiC SBD chip   | --   | --  | 0.49 | $^\circ\text{C}/\text{W}$ |
| Mounting Torque                     | $M_d$      |  |      |     | 1.5  | N-m                       |
| Terminal Connection Torque          | $M_{dt}$   |  | 1.3  | --  | 1.5  | N-m                       |
| Package Weight                      | $W_t$      |  |      | 29  |      | g                         |
| Isolation Voltage                   | $V_{ISOL}$ | $I_{ISOL} < 1\text{mA}, 50/60\text{ Hz}, t=1\text{ min}$ | 2500 | V   |      |                           |

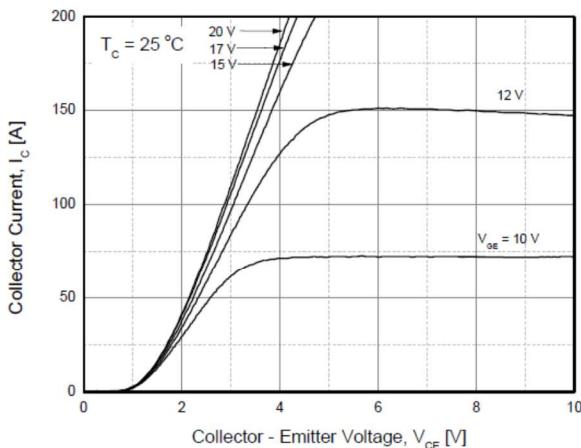
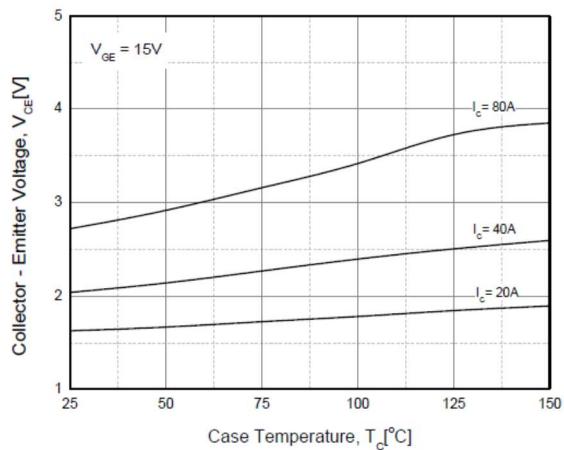
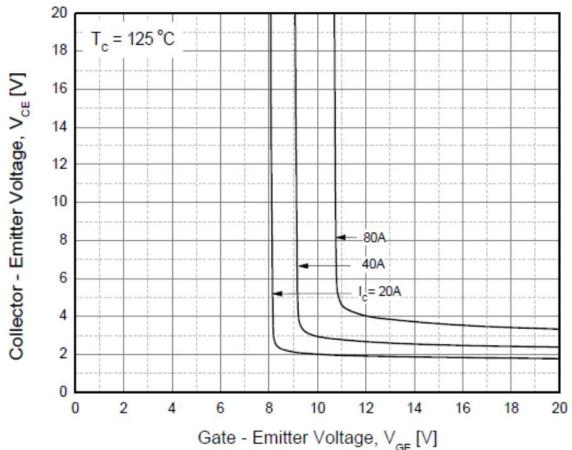
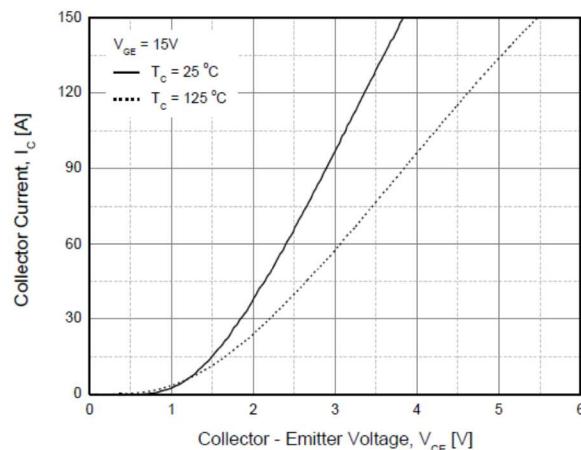
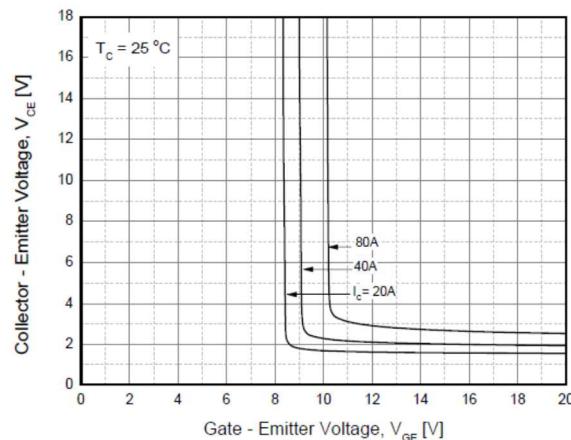
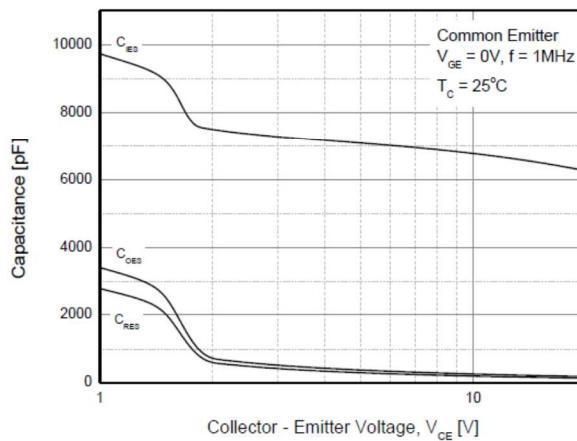
**IGBT Characteristics (2\*40A dies in parallel)**
**Fig. 1** Output characteristics

**Fig. 3** Saturation voltage vs. collector current

**Fig. 5** Saturation voltage vs. gate bias

**Fig. 2** Saturation voltage characteristics

**Fig. 4** Saturation voltage vs. gate bias

**Fig. 6** Capacitance characteristics


Fig. 7 Turn-on time vs. gate resistor

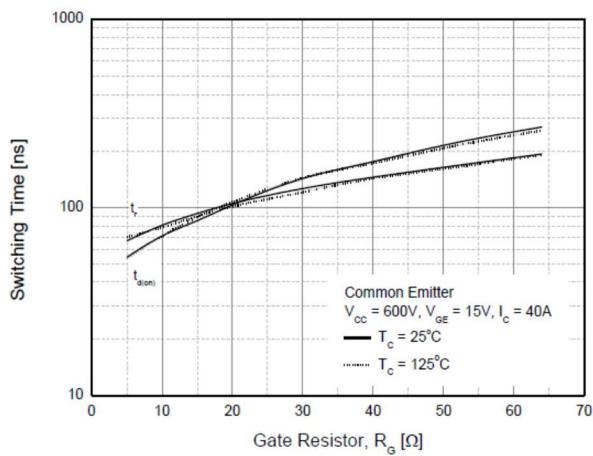


Fig. 8 Turn-off time vs. gate resistor

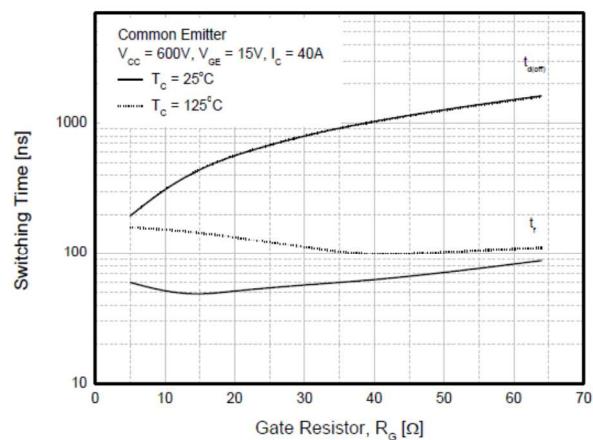


Fig. 9 Switching loss vs. gate resistor

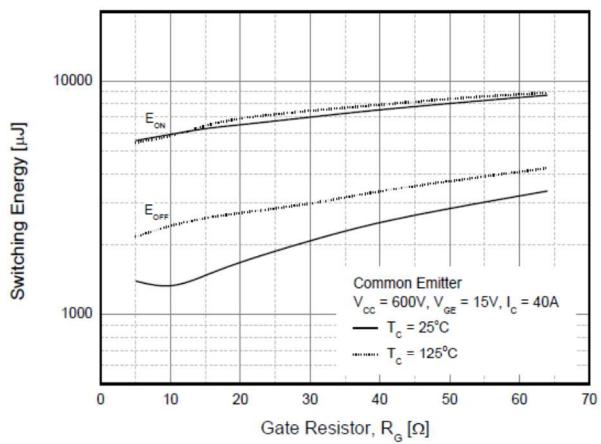


Fig. 10 Turn-on time vs. collector current

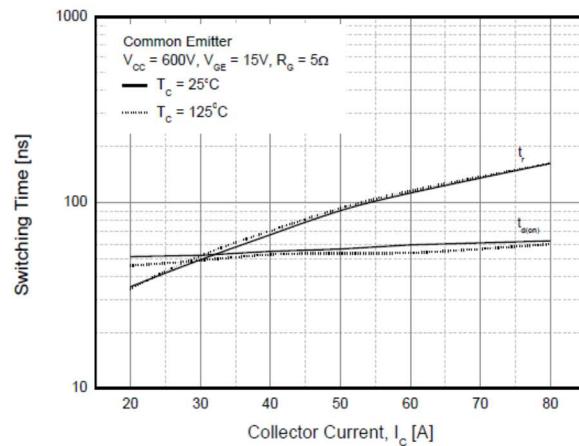


Fig. 11 Turn-off time vs. collector current

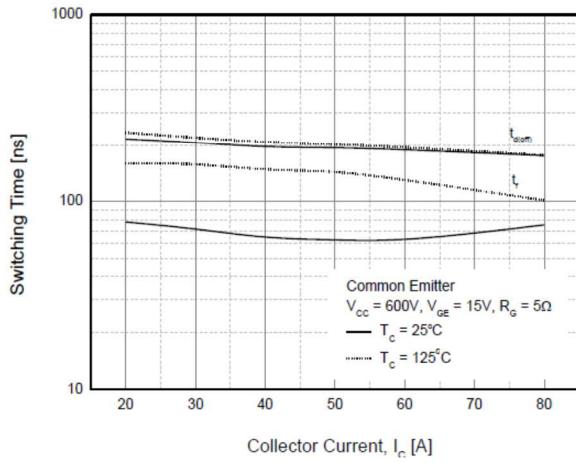


Fig. 12 Switching loss vs. collector current

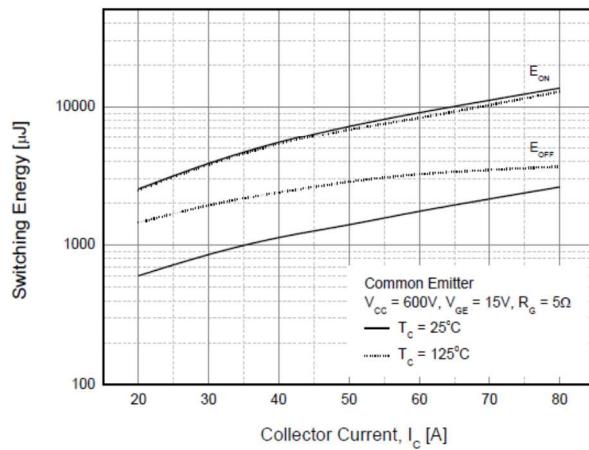


Fig. 13 Gate charge characteristics

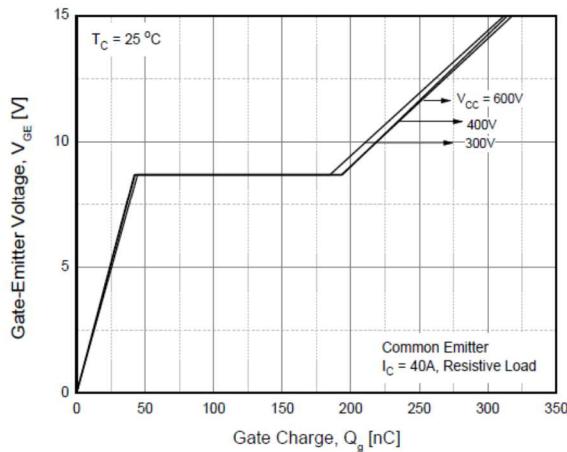


Fig. 14 SOA

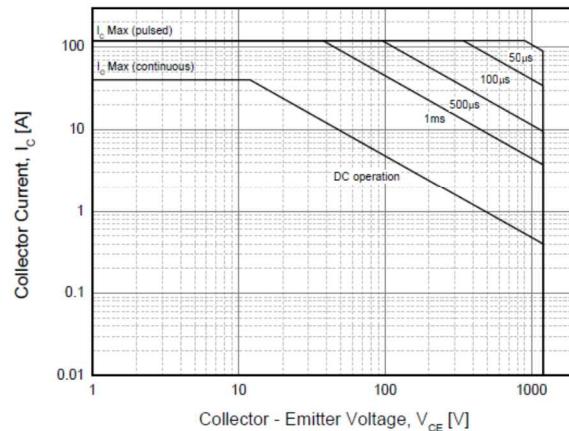


Fig. 15 RBSOA

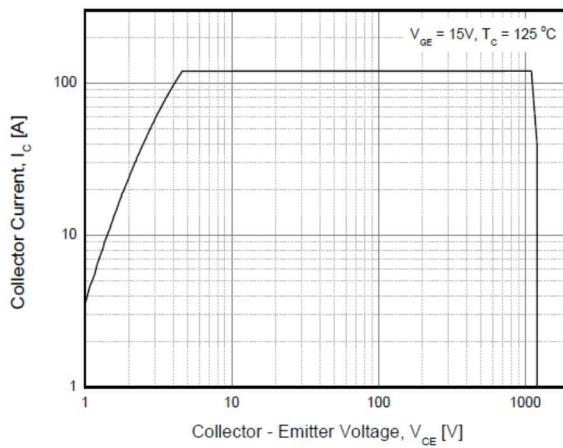
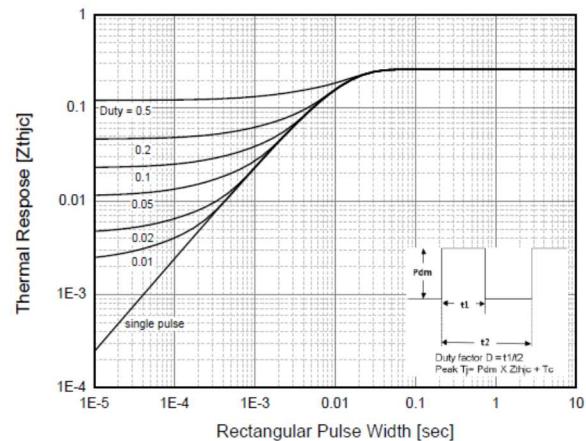
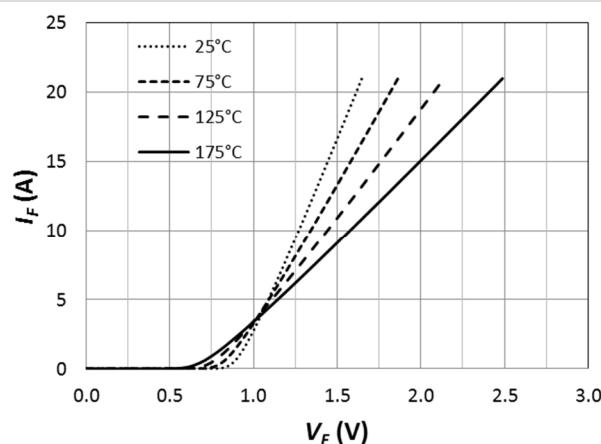
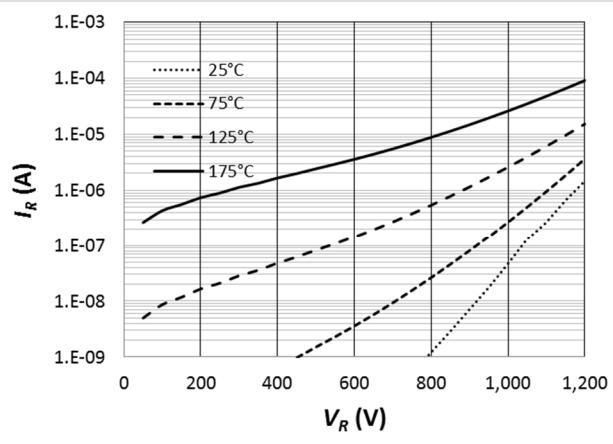
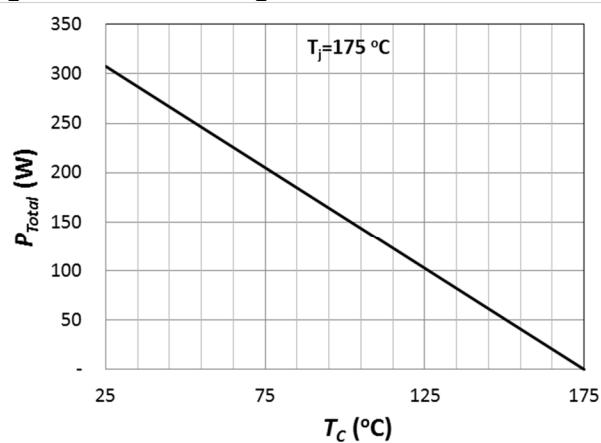
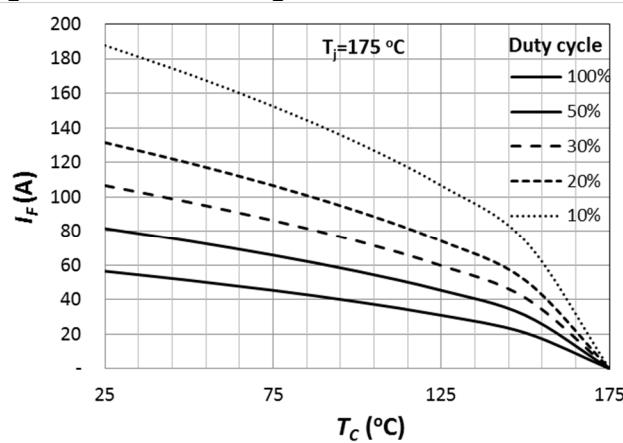
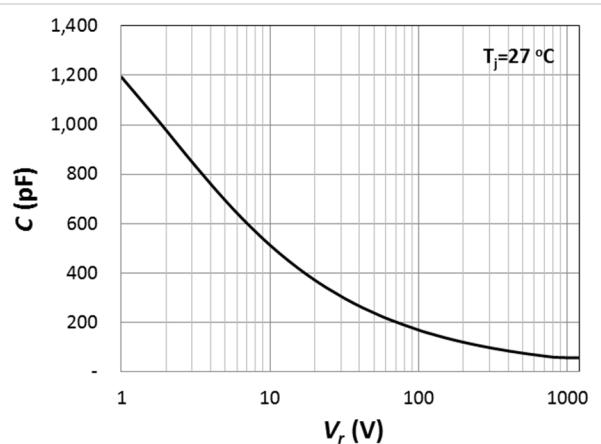
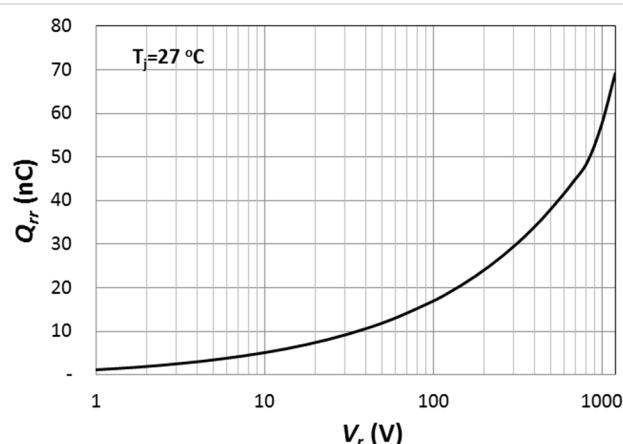
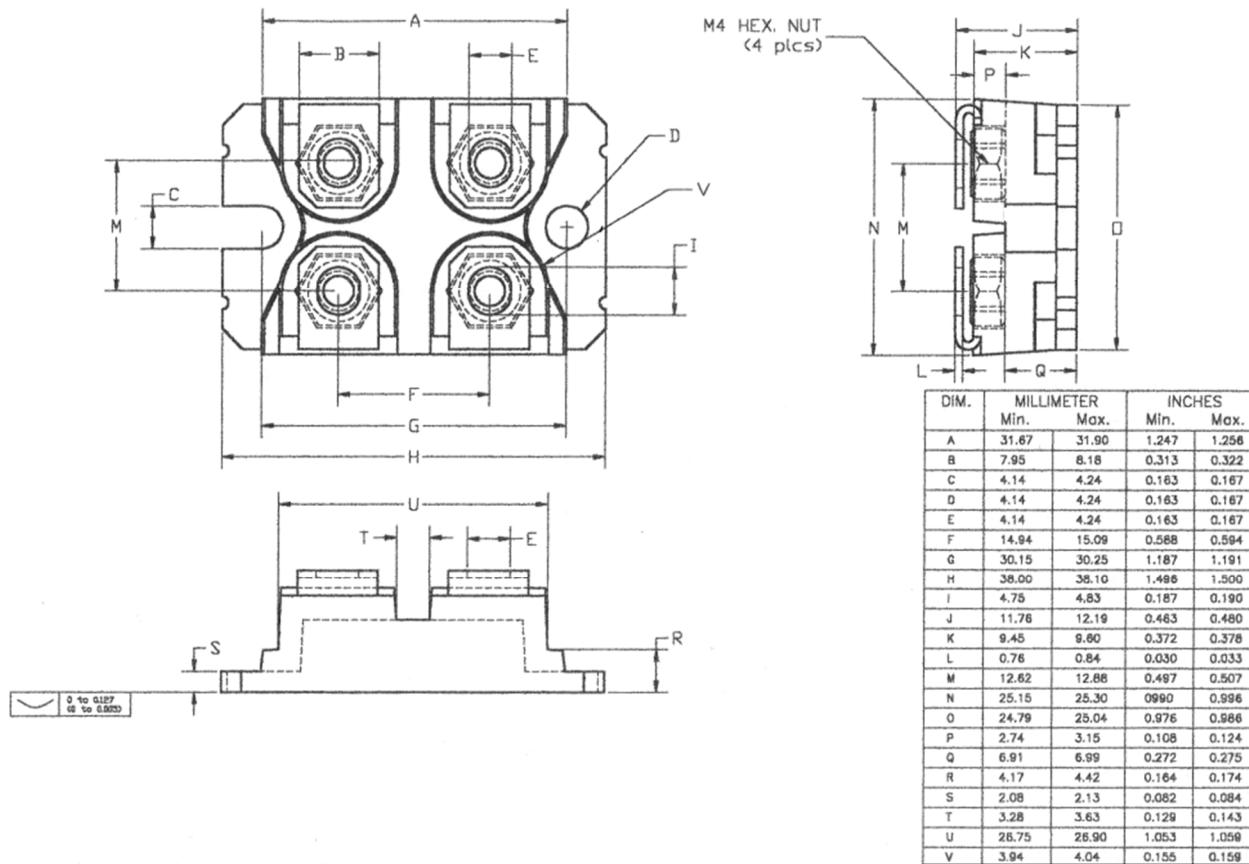


Fig. 16 Transient thermal impedance of IGBT



**Buck SiC Diode Characteristics (2\*20A dies in parallel)**
**Fig. 17 Forward Characteristics**

**Fig. 18 Reverse Characteristics**

**Fig. 19 Power Derating**

**Fig. 20 Current Derating**

**Fig. 21 Capacitance Curve**

**Fig. 22 Recovery Charge**


**SOT-227 Package Outline**

**Revision History**

| Date     | Revision | Notes                                  |
|----------|----------|--|
| 6/3/2014 | 1.0      | Initial release                        |
| 8/2/2018 | 1.1      | Correct the typo in the pin assignment |
|          |          |  |

To obtain additional technical information or to place an order for this product, please contact us. The information in this datasheet is provided by Global Power Electronics, Inc. GPE reserves the right to make changes, corrections, modifications, and improvements without notice.

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